

30V N-Channel Mosfet

FEATURES**TO-252-2L**

RDS(ON)≤ 5m Ω @VGS=10V

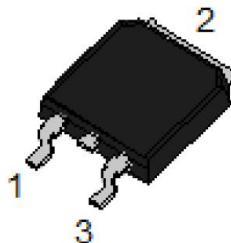
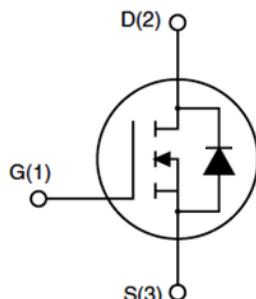
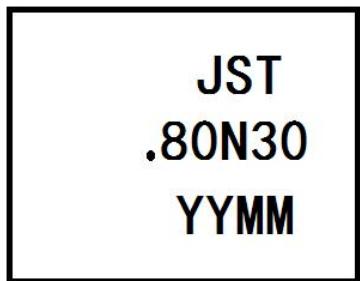
RDS(ON)≤ 7.5m Ω @VGS=4.5V

APPLICATIONS

Load Switch

PWM Application

Power Management

**MARKING****N-CHANNEL MOSFET**

YYMM:Date Code(year&month)

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Param		Max.	Units
V_{DSS}	Drain-Source Voltage		30	V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D	Continuous Drain Current	$T_c = 25^\circ\text{C}$	90	A
		$T_c = 100^\circ\text{C}$	58	A
I_{DM}	Pulsed Drain Current ^{note1}		360	A
E_{AS}	Single Pulsed Avalanche Energy ^{note2}		250	mJ
P_D	Power Dissipation	$T_c = 25^\circ\text{C}$	90	W
R_{eJC}	Thermal Resistance, Junction to Case		1.67	$^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	$^\circ\text{C}$

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Param	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$,	-	-	1.0	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$	-	-	± 100	nA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0	1.5	2.5	V
$R_{DS(\text{on})}$	Static Drain-Source on-Resistance note3	$V_{GS}=10\text{V}, I_D=20\text{A}$	-	3.6	5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=15\text{A}$	-	5	7.5	
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=15\text{A}$	-	28	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=15\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$	-	1950	-	pF
C_{oss}	Output Capacitance		-	320	-	pF
C_{rss}	Reverse Transfer Capacitance		-	240	-	pF
Q_g	Total Gate Charge	$V_{DS}=25\text{V}, I_D=20\text{A}, V_{GS}=10\text{V}$	-	42	-	nC
Q_{gs}	Gate-Source Charge		-	4	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	14	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=15\text{V}, R_i=0.75\Omega, R_{GEN}=3\Omega, V_{GS}=10\text{V}$	-	13	-	ns
t_r	Turn-on Rise Time		-	36	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	43	-	ns
t_f	Turn-off Fall Time		-	16	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Maximum Continuous Drain to Source Diode Forward Current	-	-	90	-	A
I_{sM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	360	-	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_s=30\text{A}$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	$I_f=20\text{A}, dI/dt=100\text{A}/\mu\text{s}$	-	16	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	5	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition $T_J=25^\circ\text{C}, VDD=30\text{V}, VG=10\text{V}, L=0.5\text{mH}, RG=25\Omega$

Typical Performance Characteristics

Figure 1: Output Characteristics

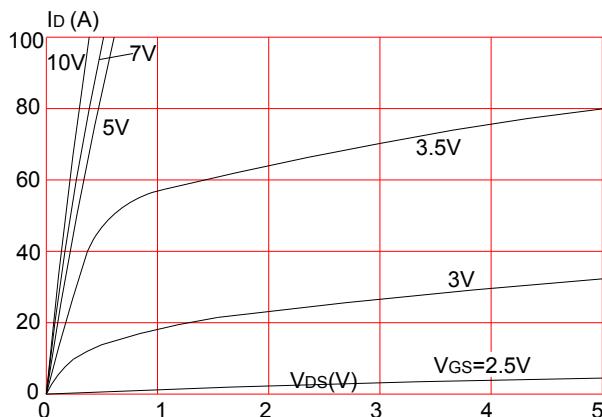


Figure 3: On-resistance vs. Drain Current

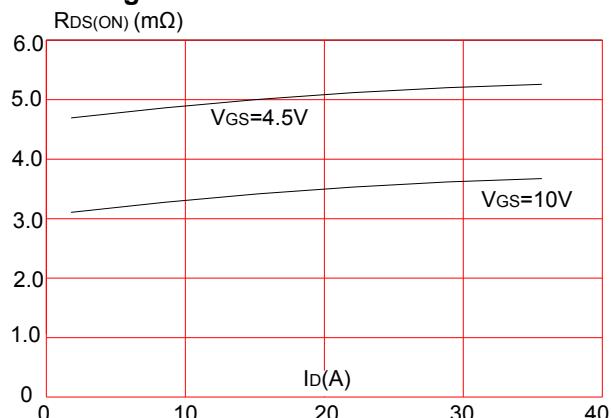


Figure 5: Gate Charge Characteristics

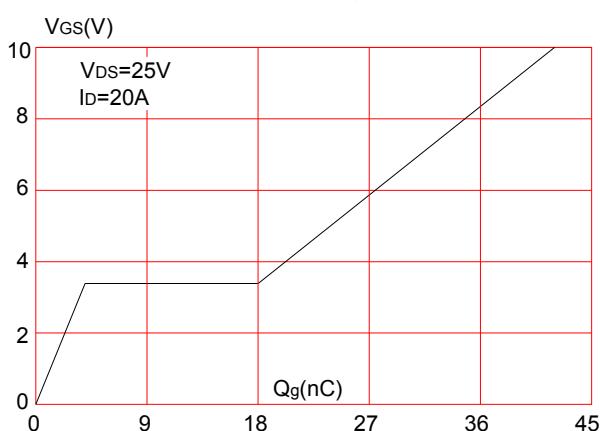


Figure 2: Typical Transfer Characteristics

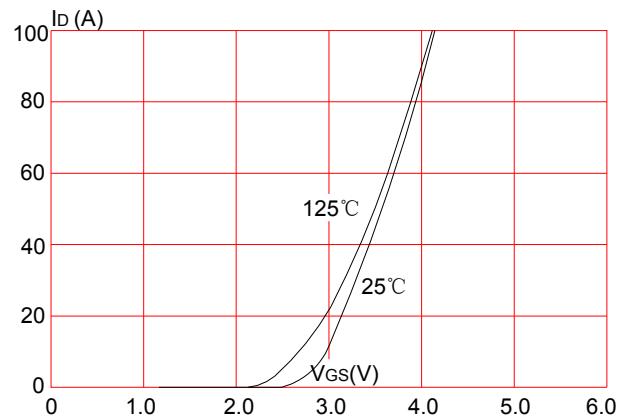


Figure 4: Body Diode Characteristics

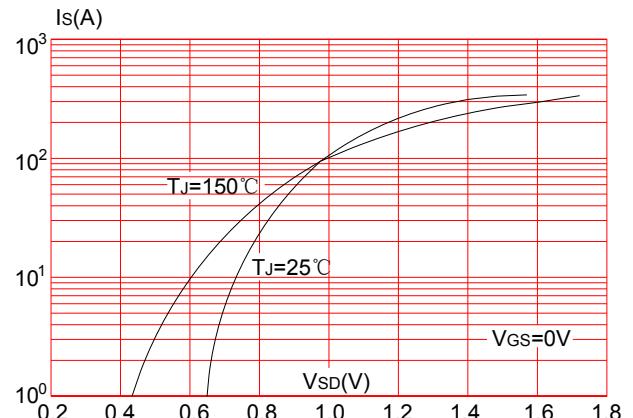


Figure 6: Capacitance Characteristics

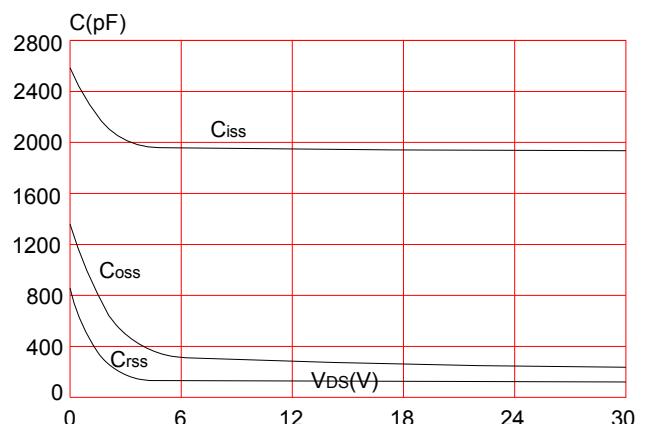


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

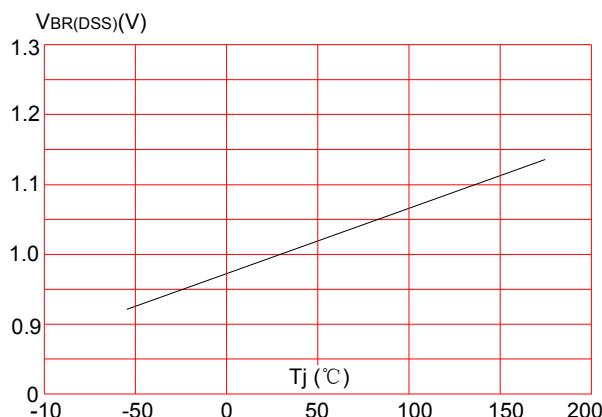


Figure 9: Maximum Safe Operating Area

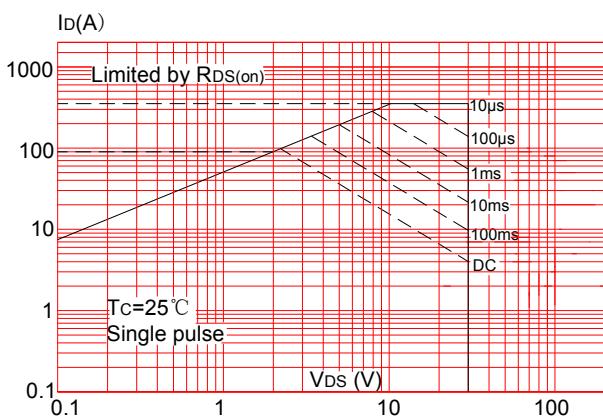


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-252)

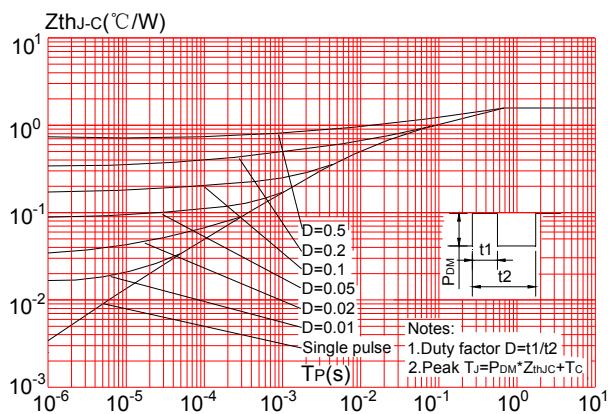


Figure 8: Normalized on Resistance vs. Junction Temperature

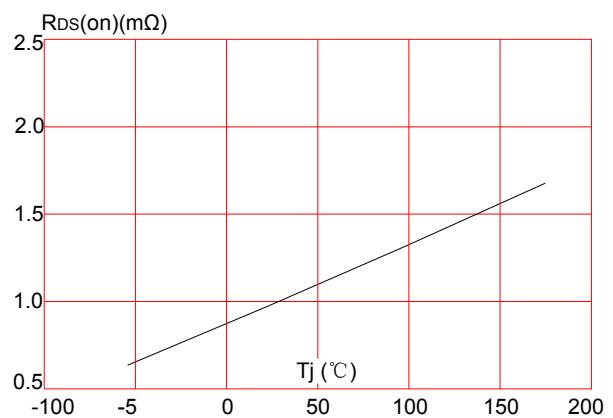
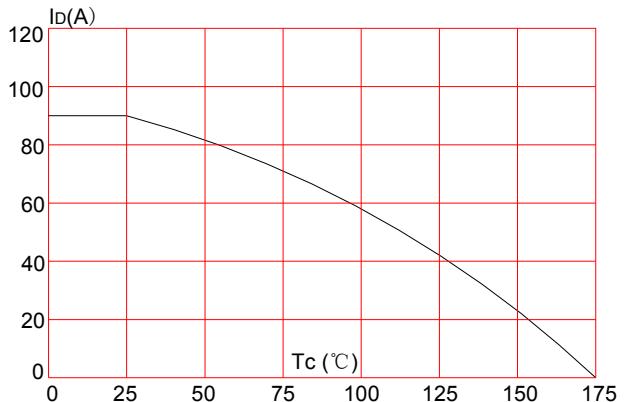
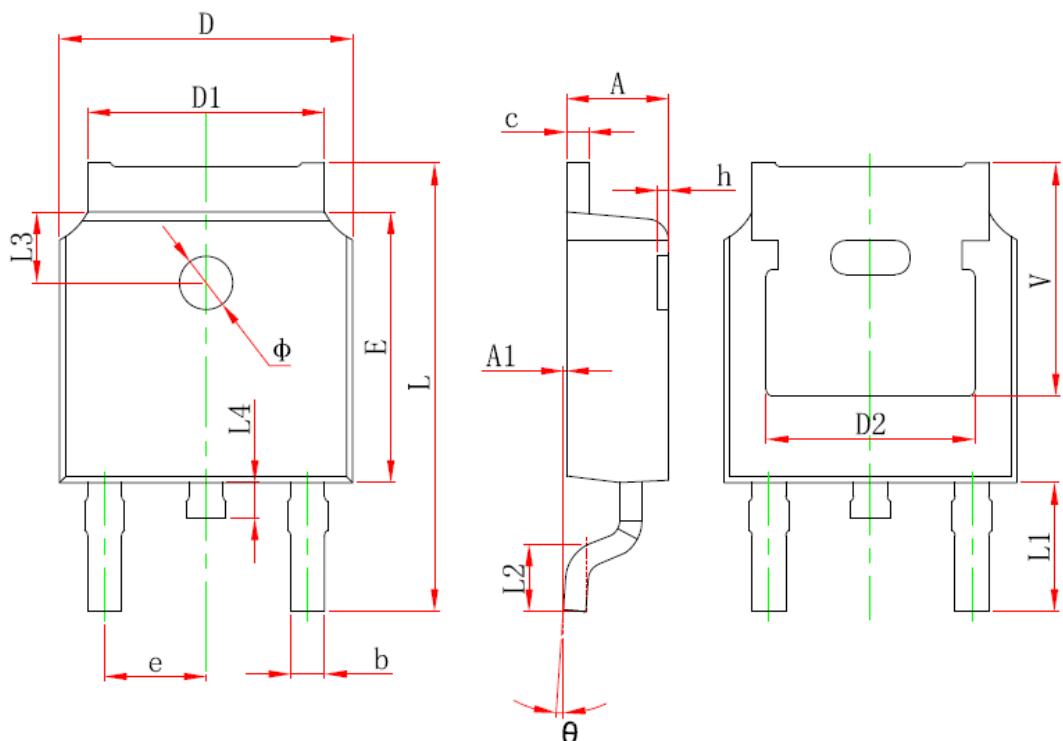


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



TO-252-2L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
phi	1.100	1.300	0.043	0.051
theta	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	

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